REV LETTER: F PAGE NO: 1 OF 1 PART NUMBER:

## Polymer PTC Devices

Surface mount fuses

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### LP-NSM050

## Features

- □ Small size of 1206
- □ Lead-free and compliant with the European Union RoHS Directive 2002/95/EC
- ☐ Fast tripping resettable circuit protection
- □ Surface mount packaging for automated assembly
- ☐ Agency Recognition: UL、CSA

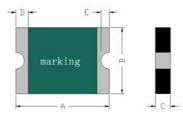




#### **Product Dimensions (mm)**

Part number -	Α	В	С	D	Е	- Part marking	
	Max.	Max.	Max.	Min.	Min.		
LP-NSM050	3.50	1.80	0.85	0.10	0.20	Α	

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Top View

Side View

#### **Electrical Characteristics**

Part number -	I <sub>H</sub>	Ι <sub>Τ</sub>	V <sub>max</sub>	I <sub>max</sub>	$T_{trip}$		Pd <sub>typ</sub>	R <sub>min</sub>	R <sub>1max</sub>
	(A)	(A)	(V)	(A)	Current(A)	Time(S)	(W)	(Ω)	<b>(Ω)</b>
LP-NSM050	0.50	1.00	6	40	8.0	0.10	0.6	0.15	0.70

I<sub>H</sub>=Hold current: maximum current at which the device will not trip at 25°C still air.

I<sub>T</sub>=Trip current: minimum current at which the device will always trip at 25 ℃ still air.

V<sub>max</sub>=Maximum voltage device can withstand without damage at rated current.

 $I_{\text{max}}$ =Maximum fault current device can withstand without damage at rated voltage.

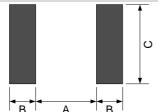
T<sub>trip</sub>=Maximum time to trip(s) at assigned current.

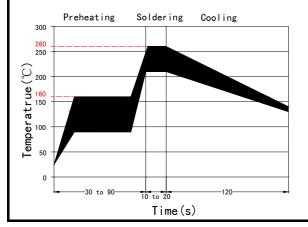
Pd<sub>typ</sub>=Typical power dissipation: typical amount of power dissipated by the device when in state air environment.

R<sub>min</sub>=Minimum device resistance at 25°C prior to tripping.

 $R_{1\text{max}}$ =Maximum device resistance measured in the nontripped state 1 hour post reflow.

#### Solder Reflow Recommendations





# | Solder Pad Layouts | | A B C | (mm) (mm) (mm)

\* Recommended reflow methods: IR, Vapor phase, hot air oven.

1.80

\* Devices can be cleaned using standard industry methods and solvents.

1.00

#### Notes:

- If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.
- Devices are not designed to be wave soldered to the bottom side of the board.

#### **Package Information**

LP-NSM050

Tape & Reel: 4000pcs per reel.

Effectivity: Reference documents shall be the issue in effect on the date of invitation for bid.

Caution: Operation beyond the rated voltage or current may result in rupture electrical arcing or flame.